## PD480PI/PD480PI1

#### **■** Features

- 1. High speed response ( $t_r$ ,  $t_f$ : TYP. 100ns at  $R_L$ = 1k $\Omega$ )
- 2. Narrow acceptance ( $\Delta\theta$ : TYP.  $\pm 20^{\circ}$ )
- 3. Compact
- 4. Lead forming type (PD480PI1)

## ■ Applications

- 1. Game machines
- 2. Optoelectronic switches
- Infrared remote controllers for TVs, VCRs, audio equipment, air conditioners, etc.

## ■ Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$ 

| Parameter                | Symbol         | Rating       | Unit |  |
|--------------------------|----------------|--------------|------|--|
| Reverse voltage          | V <sub>R</sub> | 20           | V    |  |
| Power dissipation        | P              | 75           | mW   |  |
| Operating temperature    | T opr          | - 25 to + 85 | °C   |  |
| Storage temperature      | T stg          | - 40 to + 85 | °C   |  |
| *1 Soldering temperature | T sol          | 260          | °C   |  |

<sup>\*1</sup> For 3 seconds at the position of 2.5mm from the surface of resin edge

## **■** Electro-optical Characteristics

 $(Ta= 25^{\circ}C)$ 

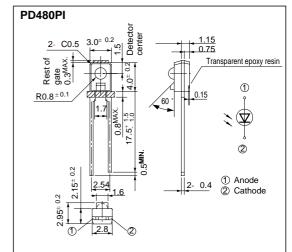
| Parameter                   | Symbol                    | Conditions                               | MIN. | TYP. | MAX. | Unit |
|-----------------------------|---------------------------|--|------|------|------|------|
| *2Short circuit current     | Isc                       | $E_V = 100 lx$                           | 1.0  | 1.7  | 2.4  | μΑ   |
| Dark current                | $I_d$                     | V <sub>R</sub> = 10V, E <sub>V</sub> = 0 | -    | -    | 10   | nA   |
| Terminal capacitance        | Ct                        | V <sub>R</sub> = 0, f= 1MHz              | -    | 4.0  | 10   | pF   |
| Peak sensitivity wavelength | λp                        | -  | -    | 950  | -    | nm   |
| Response time               | $t_{\rm r}$ , $t_{\rm f}$ | $R_L= 1k\Omega$ , $V_R= 10V$             | -    | 100  | 250  | ns   |
| Half intensity angle        | Δθ                        | -  | -    | ± 20 | -    | ۰    |

<sup>\*2</sup> E v: Illuminance by CIE standard light source A(tungsten lamp)

# High Speed, Narrow Acceptance Photodiodes

#### ■ Outline Dimensions

(Unit: mm)



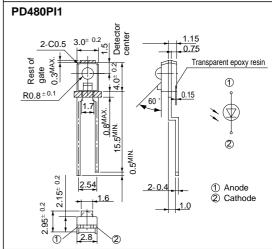


Fig. 1 Power Dissipation vs.
Ambient Temperature

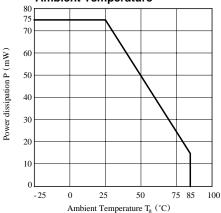


Fig. 3 Dark Current vs.

Ambient Temperature

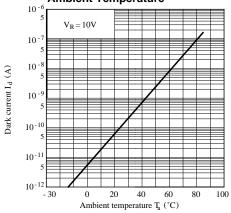


Fig. 5 Terminal Capacitance vs. Reverse Voltage

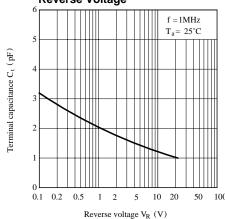


Fig. 2 Spectral Sensitivity

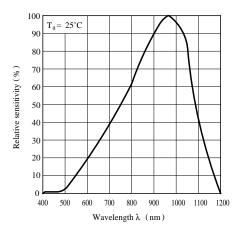


Fig. 4 Dark Current vs. Reverse Voltage

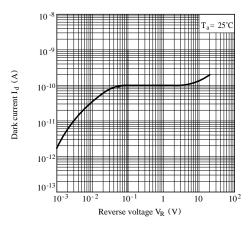
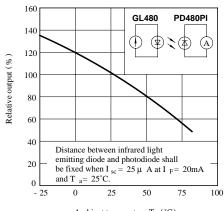


Fig. 6 Relative Output vs. Ambient Temperature



Ambient temperature Ta (°C)

Fig. 7 Sensitivity Diagram  $(T_a = 25^{\circ}C)$ 

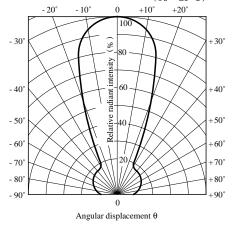
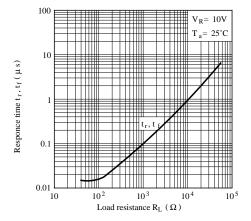
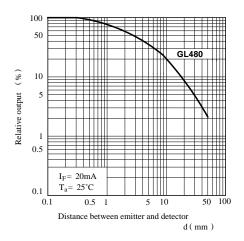


Fig. 9 Responce Time vs. Load Resistance

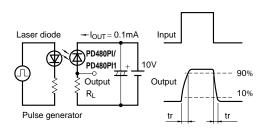


• Please refer to the chapter "Precautions for Use."

Fig. 8 Relative Output vs. Distance



### **Test Circuit for Responce Time**



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  - Office automation equipment
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- Gas leakage sensor breakers
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- Various safety devices, etc.
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